imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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Very Low Leakage Trench-based Schottky Rectifier

Features

- Fine Lithography Trench–based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb–Free and Halide–Free Devices

Typical Applications

- Switching Power Supplies including Notebook / Netbook Adapters, ATX and Flat Panel Display
- High Frequency and DC-DC Converters
- Freewheeling and OR-ing Diodes
- Reverse Battery Protection
- LED Lighting
- Instrumentation

Mechanical Characteristics:

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94–0 @ 0.125 in.
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements



ON Semiconductor®

http://onsemi.com

TRENCH SCHOTTKY RECTIFIERS **10 AMPERES 120 VOLTS**





- = Work Week ΖZ
 - = Lot Traceability

ORDERING INFORMATION

| Device | Package | Shipping† |
|-------------------|----------------------|-----------------------|
| NTS10120EMFST1G | SO–8 FL (Pb–Free) | 1500 / Tape & Reel |
| NTS10120EMFST3G | SO–8 FL (Pb–Free) | 5000 / Tape & Reel |
| NRVTS10120EMFST1G | SO–8 FL (Pb–Free) | 1500 / Tape & Reel |
| NRVTS10120EMFST3G | SO–8 FL (Pb–Free) | 5000 / Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|---|--|-------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _B | 120 | V |
| Average Rectified Forward Current (Rated V_R , $T_C = 165^{\circ}C$) | I _{F(AV)} | 10 | A |
| Peak Repetitive Forward Current, (Rated V _R , Square Wave, 20 kHz, T _C = 163°C) | I _{FRM} | 20 | A |
| Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) | I _{FSM} | 200 | A |
| Storage Temperature Range | T _{stg} | -65 to +175 | °C |
| Operating Junction Temperature | TJ | -55 to +175 | °C |
| Unclamped Inductive Switching Energy (10 mH Inductor, Non-repetitive) | E _{AS} | 100 | mJ |
| ESD Rating (Human Body Model) | | 3B | |
| ESD Rating (Machine Model) | | M4 | |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Тур | Max | Unit |
|---|-----------------------|-----|-----|------|
| Thermal Resistance, Junction-to-Case, Steady State (Assumes 600 mm ² 1 oz. copper bond pad, on a FR4 board) | $R_{	extsf{	heta}JC}$ | 1.8 | - | °C/W |

ELECTRICAL CHARACTERISTICS

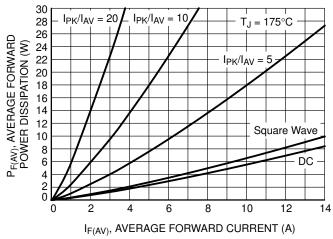
| Rating | Symbol | Тур | Мах | Unit |
|--|----------------|-------|------|------|
| Instantaneous Forward Voltage (Note 1) | V _F | | | V |
| $(I_{F} = 5 \text{ A}, T_{J} = 25^{\circ}\text{C})$ | | 0.6 | - | |
| (I _F = 10 A, T _J = 25°C) | | 0.735 | 0.82 | |
| (I _F = 5 A, T _{.I} = 125°C) | | 0.515 | _ | |
| $(I_F = 10 \text{ Å}, T_J = 125^{\circ}\text{C})$ | | 0.588 | 0.63 | |
| Instantaneous Reverse Current (Note 1) | I _R | | | |
| $(V_{R} = 90 \text{ V}, \text{ T}_{J} = 25^{\circ}\text{C})$ | | 1.0 | - | μA |
| (Rated dc Voltage, $T_J = 25^{\circ}C$) | | 3.75 | 30 | μΑ |
| (V _B = 90 V, T _J = 125°C) | | 2.0 | _ | mA |
| (Rated dc Voltage, $T_J = 125^{\circ}C$) | | 3.1 | 20 | mA |

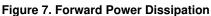
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Pulse Test: Pulse Width = $300 \ \mu$ s, Duty Cycle $\leq 2.0\%$.

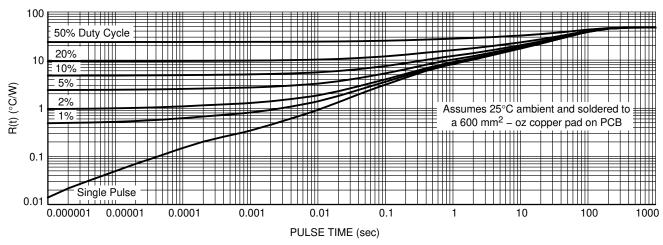
100 100 iF, INSTANTANEOUS FORWARD i_F, INSTANTANEOUS FORWARD CURRENT (A) L 01 T_A = 125°C T_A = 125°C 010 CURRENT (A) = 150°C TΑ T_A = 150°C = 175°C $T_A = 175^{\circ}C$ = 25°C = 25°C TΔ ΙA -55°C -55°C $T_A =$ 0.1 0.1 0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1.0 1.1 1.2 1.3 0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1.0 1.1 1.2 1.3 0 0 V_F, INSTANTANEOUS FORWARD VOLTAGE (V) V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Figure 1. Typical Instantaneous Forward Figure 2. Maximum Instantaneous Forward Characteristics Characteristics (¥) 1.E+00 1.E-01 (¥) 1.E+00 1.E-01 1.E-02 1.E-02 1.E-03 1.E-03 1.E-04 1.E-05 1.E-05 1.E-05 1.E-07 T_A = 175°C 150 $T_A = 175^{\circ}C$ T_A = 125°C T_A = 150°C U 1.E−02 SH 1.E−03 H 1.E−03 = 125°C TΑ H S1.E-04 031.E-05 1.E-06 T_A = 25°C T_A = 25°C SZ .E-07 90 100 110 120 _m 0 10 20 30 40 50 60 70 80 0 10 20 30 40 50 60 70 80 90 100 110 120 V_R, INSTANTANEOUS REVERSE VOLTAGE (V) V_R, INSTANTANEOUS REVERSE VOLTAGE (V) Figure 3. Typical Reverse Characteristics Figure 4. Maximum Reverse Characteristics I_{F(AV)}, AVERAGE FORWARD CURRENT (A) 10,000 25 $T_J = 25^{\circ}C$ $R_{\theta JC} = 1.8^{\circ}C/W$ C, JUNCTION CAPACITANCE (pF) 20 1000 DC 15 Square Wave 10 100 5 10 0 120 140 0.1 110 130 150 160 170 10 100 1 V_R, REVERSE VOLTAGE (V) T_C, CASE TEMPERATURE (°C) Figure 5. Typical Junction Capacitance Figure 6. Current Derating

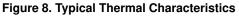
TYPICAL CHARACTERISTICS

TYPICAL CHARACTERISTICS









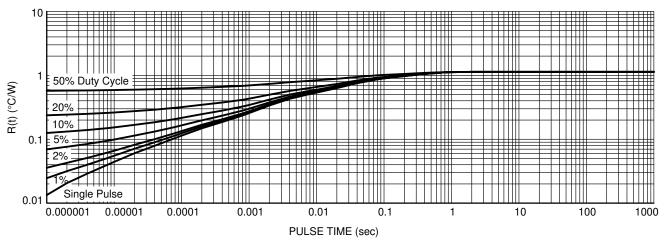
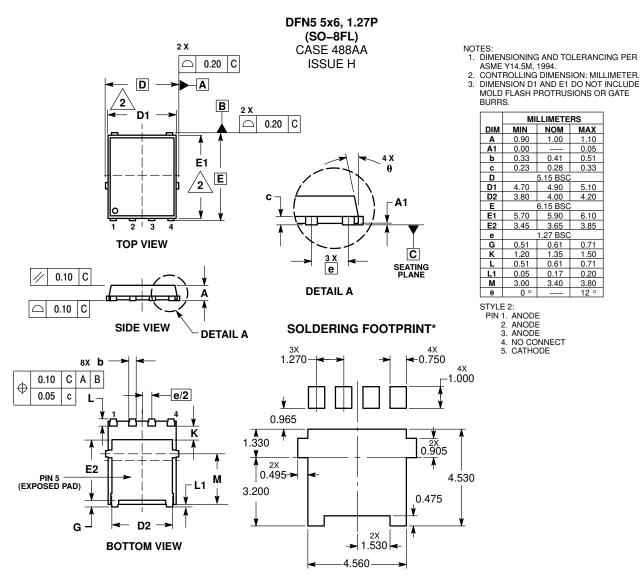


Figure 9. Typical Transient Thermal Response Characteristics, Junction-to-Case

PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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